# IS66WVS8M8FALL/BLL
# IS67WVS8M8FALL/BLL

## 64Mb SerialRAM
### 1.8V/3.0V, 104MHZ, SPI & QPI PROTOCOL

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# 64Mb SerialRAM

**1.8V/3.0V, 104MHz, SPI & QPI Protocol**

## FEATURES

- **Industry Standard Serial Interface**
  - SPI Protocol: 1-1-1 & 1-4-4 operation
  - QPI protocol: 4-4-4 operation
  - Low Signal Counts :6 Signal pins (CE#, CLK, SIO0~SIO3)
- **High Performance**
  - Clock Rate:

    33MHz(max) for normal read
    104MHz(max) for fast read
  - Page Size: 1024 Byte
  - Configurable Wrapped Burst Length:

    32 and 1024 (Default=1024)
  - Always Wrapped Burst Operation within page.
  - Drive Strength: 50 ohm
- **Low Power Consumption**
  - Single 1.65V to 1.95V Voltage Supply
  - Single 2.7V to 3.6V Voltage Supply
  - Typical Standby Current:

    120 µA for 1.8V, 150uA for 3.0V
- **Hardware Features**
  - **CLK Input**: Serial clock input
  - **SIO0 – SIO3**:

    Serial Data Input or Serial Data Output
- **Temperature Grades**
  - Industrial: -40°C to +85°C
  - Auto (A1) Grade: -40°C to +85°C
  - Auto (A2) Grade: -40°C to +105°C
- **Industry Standard PACKAGE**
  - K = 8-contact WSON 6x5mm
  - T = 8-contact USON 4x3mm
  - N = 8-pin SOIC 150mil
  - KGD (Call Factory)
  - Green Package (RoHS Compliant, Halogen-Free) and TSCA Compliant



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## GENERAL DESCRIPTION

The IS66/67WVS8M8FALL/BLL are integrated memory device containing 64Mb Pseudo Static Random Access Memory using a self-refresh DRAM array organized as 8M words by 8 bits.

The device supports SPI (Serial Peripheral Interface) & QPI (Quad Peripheral Interface) protocols, Very Low Signal Count (6 signal pins; CLK, CE#, and 4 SIOs), Hidden Refresh Operation, and Industrial temperature and Automotive A2 grade temperature.

In-Band Reset is supported instead of dedicated RESET# pin, and minimum transferred data size is 8bit.

## PERFORMANCE SUMMARY

| **Read / Write Operation** | |
|---|---|
| Maximum Clock Rate | 104MHz |
| Maximum Clock to Access Time at 104MHz | 7ns |

| **Maximum Current Consumption** | | |
|---|---|---|
| Burst Read or Write (SPI mode, 33MHz) | | 5mA |
| Burst Read or Write (QPI mode, 104MHz) | | 10mA |
| Standby ($I_{SB1}$) | 85°C | 200 uA |
| | 105°C | 250 uA |


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**TABLE OF CONTENTS**


FEATURES ..... 2
GENERAL DESCRIPTION ..... 3
PERFORMANCE SUMMARY ..... 3
TABLE OF CONTENTS ..... 4
1. PIN CONFIGURATION & Descriptions ..... 6
2. Block Diagram ..... 8
3. Power-up Initialization ..... 9
4. Interface Description ..... 10
4.1 Address Space ..... 10
4.2 Page Length ..... 10
4.3 DriveR Strength ..... 10
4.4 POWER-ON STATUS ..... 10
4.5 Command/Address Latching Truth ..... 10
4.6 READ/WRITE Termination ..... 11
5. READ/WRITE OPERATIONS ..... 12
5.1 SPI READ OPERATIONS ..... 12
5.2 SPI WRITE OPERATIONS ..... 14
5.3 QPI MODE ..... 15
5.4 QPI Fast READ Operation ..... 16
5.5 QPI WRITE Operation ..... 17
5.6 QPI EXIT Operation ..... 17
5.7 Read ID Operation ..... 18
5.8 RESET Operation ..... 19
5.9 Set Burst Length Operation ..... 20
5.10 In-BAND RESET Operation ..... 21
5.11 Deep POWER DOWN MODE ..... 23
6. REGISTER ..... 25
6.1 DEVICE IDENTIFICATION REGISTER ..... 25
7. ELECTRICAL CHARACTERISTICS ..... 26
7.1 ABSOLUTE MAXIMUM RATINGS (1) ..... 26
7.2 OPERATING RANGE ..... 26
7.3 DC CHARACTERISTICS ..... 27
7.4 AC Measurement Conditions ..... 28
7.5 PIN CAPACITANCE (TA = 25°C, VCC=1.8V/ 3V, 1MHz) ..... 28
7.6 AC CHARACTERISTICS ..... 29
7.7 INPUT/OUTPUT TIMING ..... 30
8. PACKAGE TYPE INFORMATION ..... 31
8.1 8- Contact Ultra-Thin Small Outline No-Lead (WSON) PACKAGE 6X5MM (K) ..... 31




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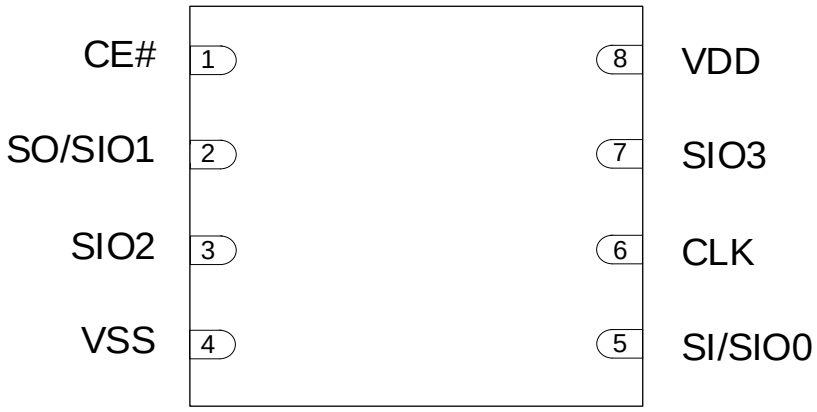
8.2 8-Pin JEDEC 150mil Broad Small Outline Integrated Circuit (SOIC) Package (N) ..... 33
8.3 12-BALL WLCSP (Y) ..... 34
9. ORDERING INFORMATION – Valid Part Numbers ..... 35



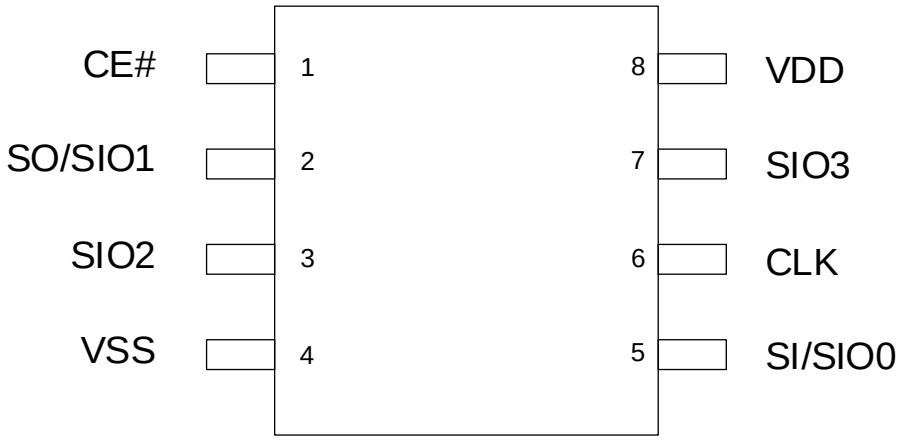
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## 1. PIN CONFIGURATION & Descriptions

**8-contact WSON 6 x 5mm, 8-contact USON 4 x 3mm**




**8-pin SOIC, 150mil**





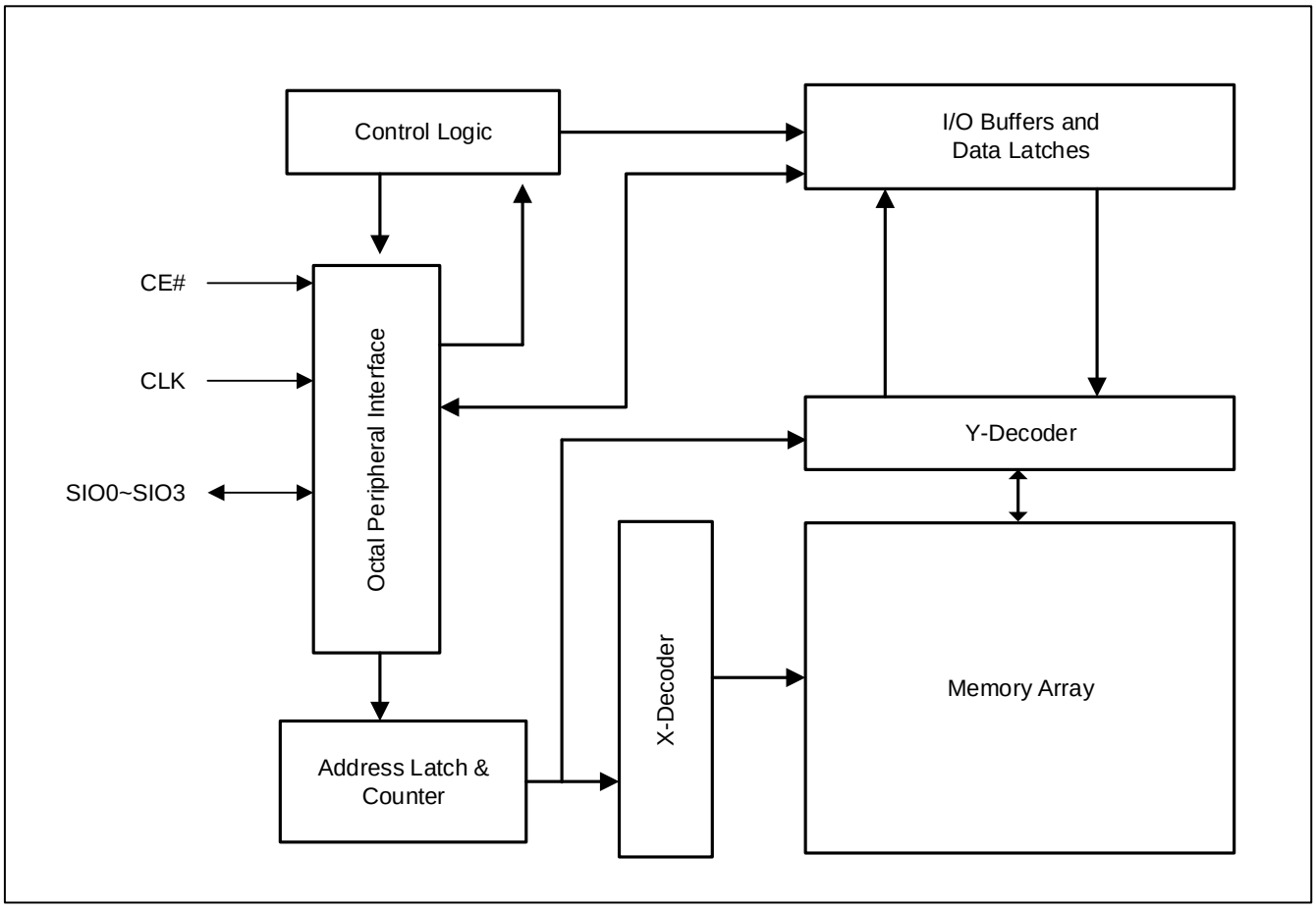

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**PIN DESCRIPTIONS**

| SYMBOL | TYPE | DESCRIPTION |
|---|---|---|
| CE# | INPUT | **Chip Select:** |
| SI/SIO0 | INPUT/OUTPUT | **Serial Data Input (SPI Mode) or Serial Data Input/Output (QPI Mode)** |
| SO/SIO1 | INPUT/OUTPUT | **Serial Data Output (SPI Mode) or Serial Data Input/Output (QPI Mode)** |
| SIO2, SIO3 | INPUT/OUTPUT | **RFU (SPI Mode) or Serial Data Input/Output (QPI Mode)** |
| CLK | INPUT | **Serial Data Clock:** Synchronized Clock for input and output timing operations. |
| VDD | POWER | **Power Supply** |
| VSS | GROUND | **Ground** |
| RFU | - | **Reserved for Future Use** |


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## 2. Block Diagram





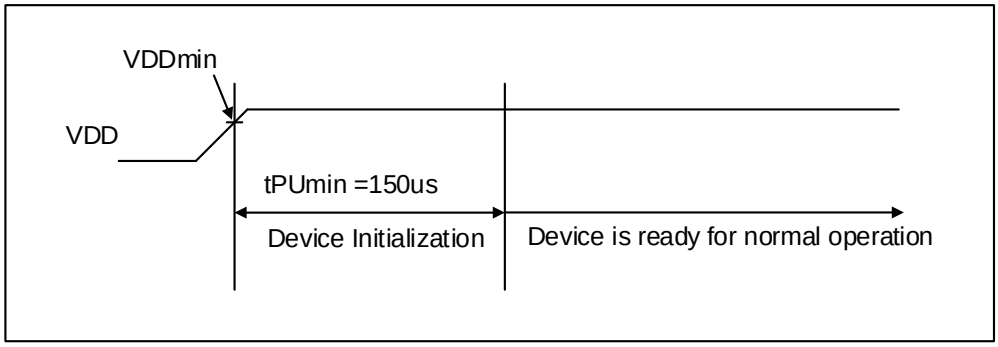

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## 3. Power-up Initialization

The SPI/QPI includes on-chip voltage sensor used to start the self-initialization process. When VDD reaches a stable level at above the minimum VDD, the device will need 150us to complete its self-initialization process.

After the 150us period, the device will be ready for normal operation.

**Figure 3.1 POWER-UP Timing**





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# 4. Interface Description

## 4.1 ADDRESS SPACE

Serial PSRAM device is byte-addressable. 64Mb device is addressed with A22 to A0.

## 4.2 PAGE LENGTH

Read and Write operations are always in wrap mode within 1024 byte.

## 4.3 DRIVER STRENGTH

Driver strength is 50 ohm measured at ½ VDD.

## 4.4 POWER-ON STATUS

The device powers up in SPI mode.
At least one clock pulse of CE# HIGH is needed before beginning any operations.

## 4.5 COMMAND/ADDRESS LATCHING TRUTH

The device recognizes the following commands specified by the various input methods.

**Table 4.1 Commands recognized by the device**

| | SPI Mode | | | | | | QPI Mode | | | | |
|---|---|---|---|---|---|---|---|---|---|---|---|
| Command | **Code** | **CMD** | **Add** | **Wait Cycle** | **DIO** | **Max Freq.** | **CMD** | **Add** | **Wait Cycle** | **DIO** | **Max Freq.** |
| Read | **03h** | S | S | 0 | S | 33 | **Q** | **Q** | **4** | **Q** | **84** |
| Fast Read | **0Bh** | S | S | 8 | S | 104 | Q | Q | 4 | Q | 84 |
| Quad IO Read | **EBh** | S | Q | 6 | Q | 104 | Q | Q | 6 | Q | 104 |
| Write | **02h** | S | S | 0 | S | 104 | Q | Q | 0 | Q | 104 |
| Quad IO Write | **38h** | S | Q | 0 | Q | 104 | Q | Q | 0 | Q | 104 |
| Enter QPI mode | **35h** | **S** | **-** | **-** | **-** | **-** | **NA** | | | | |
| Exit QPI mode | **F5h** | **NA** | | | | | Q | - | - | - | 104 |
| RESET Enable | **66h** | **S** | **-** | **-** | **-** | 104 | Q | - | - | - | 104 |
| RESET | **99h** | **S** | **-** | **-** | **-** | 104 | Q | - | - | - | 104 |
| Set Burst Length | **C0h** | **S** | **-** | **-** | **-** | 104 | Q | - | - | - | 104 |
| Read ID | **9Fh** | S | S | 0 | S | 104 | **Q** | - | **6** | **Q** | **104** |
| DPD mode Entry | **B9h** | S | **-** | **-** | **-** | 104 | **Q** | - | **-** | **-** | **104** |

**Note:**

**1. 03h command in QPI mode is the same with and 0Bh command in QPI Mode.**



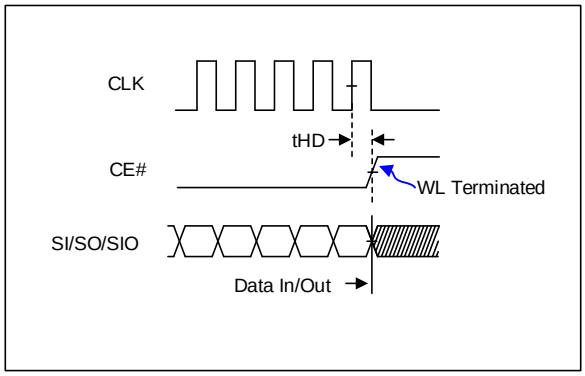
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### 4.6 READ/WRITE TERMINATION

All reads and writes must be followed immediately by a clock pulse of CE# HIGH in order to terminate the read and writes, and set the device into standby status.

CE# must transition to HIGH after the tHD (Clock rising edge to CE# HIGH).

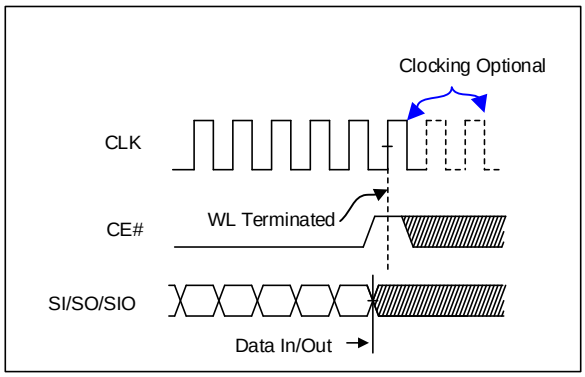
**Figure 4.1 Command Termination (Standard Device)**




As for optional device, one more clock is required to terminate operation with CE# not active setup time and hold time.

**Call factory for optional device.**

**Figure 4.2 Command Termination (Optional Device)**





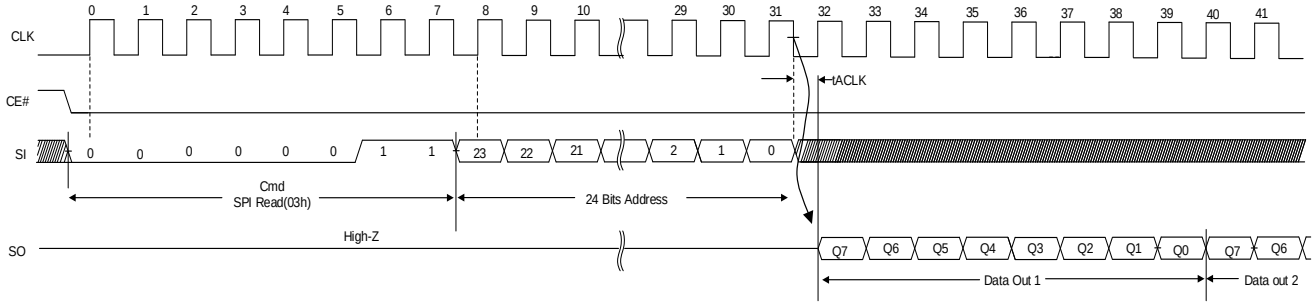
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# 5. READ/WRITE OPERATIONS

## 5.1 SPI READ OPERATIONS

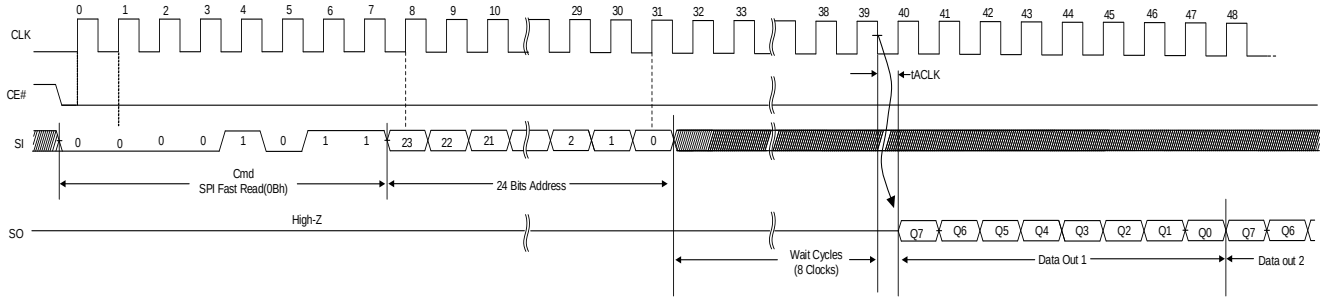
For all reads, data will be available for tACLK after the falling edge of clock. SPI reads can be done in three ways:
03h: Serial CMD, Serial IO, slow frequency (1-1-1, 0 Wait Cycle)
0Bh: Serial CMD, Serial IO, fast frequency (1-1-1, 8 Wait Cycles)
EBh: Serial CMD, Quad IO, fast frequency (1-4-4, 6 Wait Cycles)

**Figure 5.1 SPI Read, 03h (1-1-1, Max frequency: 33MHz)**




**Note:**
**1. Data out goes to High-Z after CE# transitions to HIGH (tHZ).**

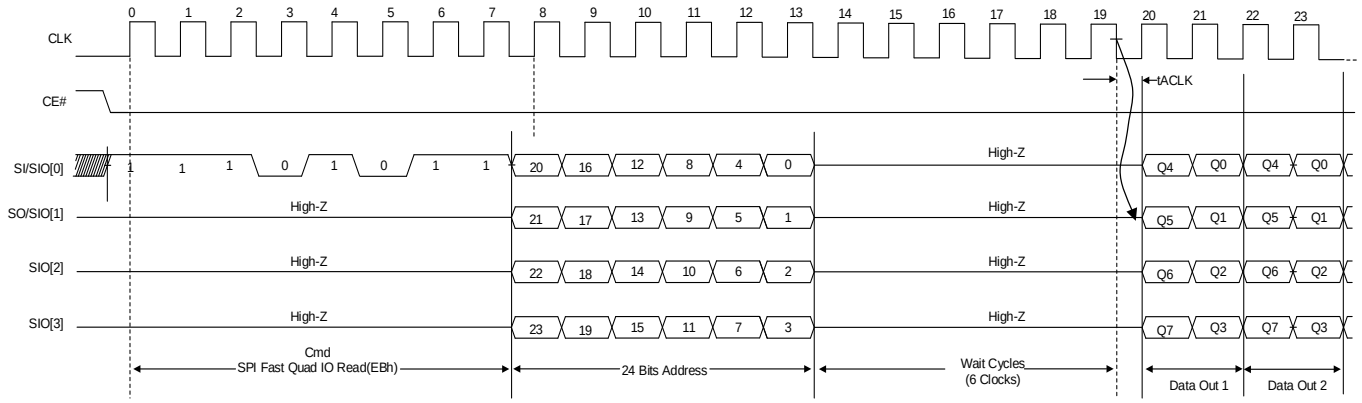
**Figure 5.2 SPI Fast Read, 0Bh (1-1-1, Max frequency: 104MHz)**




**Note:**
**1. Data out goes to High-Z after CE# transitions to HIGH (tHZ).**


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**Figure 5.3 SPI Fast Quad IO Read, EBh (1-4-4, Max frequency: 104MHz)**




**Note:**

**1. Data out goes to High-Z after CE# transitions to HIGH (tHZ).**



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## 5.2 SPI WRITE OPERATIONS

02h: Serial CMD, Serial IO, slow frequency (1-1-1, 0 Wait Cycle)
38h: Serial CMD, Quad IO, fast frequency (1-4-4, 0 Wait Cycles)

**Figure 5.4 SPI Write Command 02h (1-1-1)**

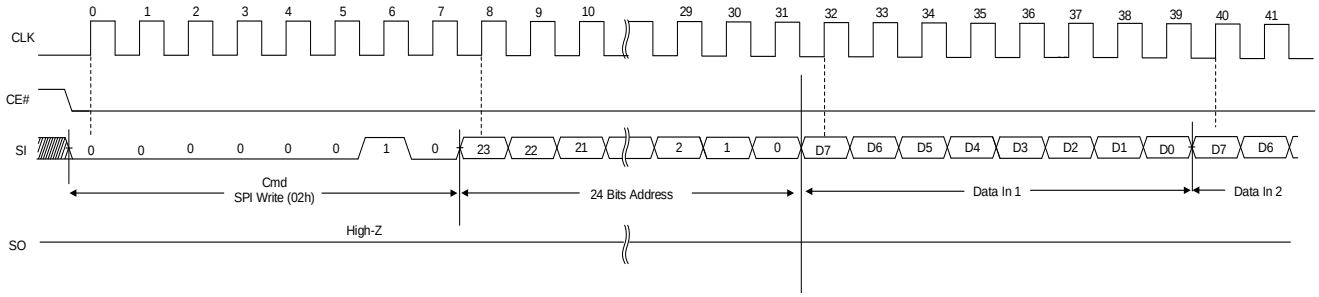
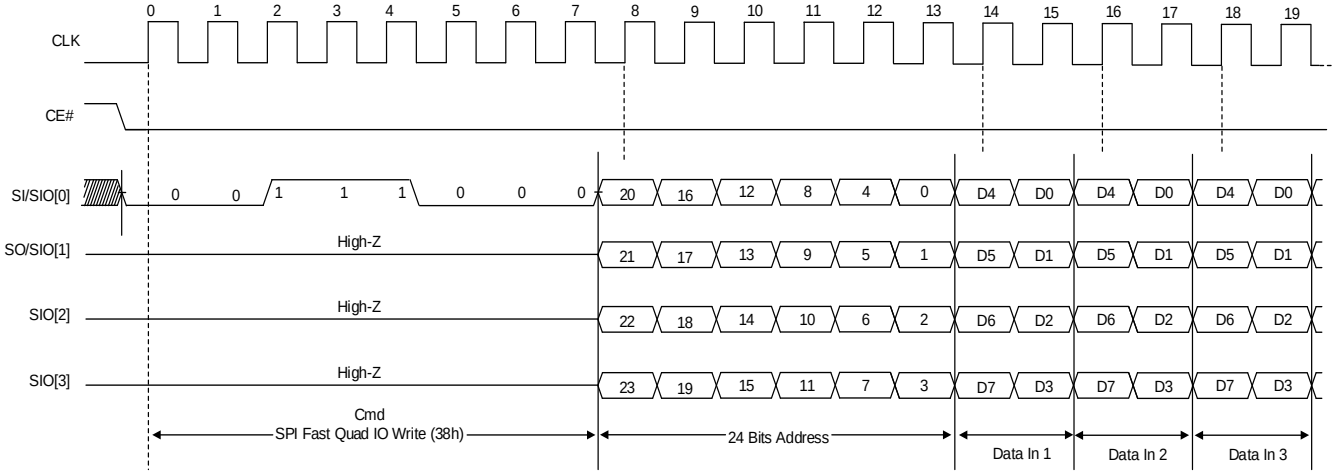



**Figure 5.5 SPI Quad IO Write command 38h (1-4-4)**



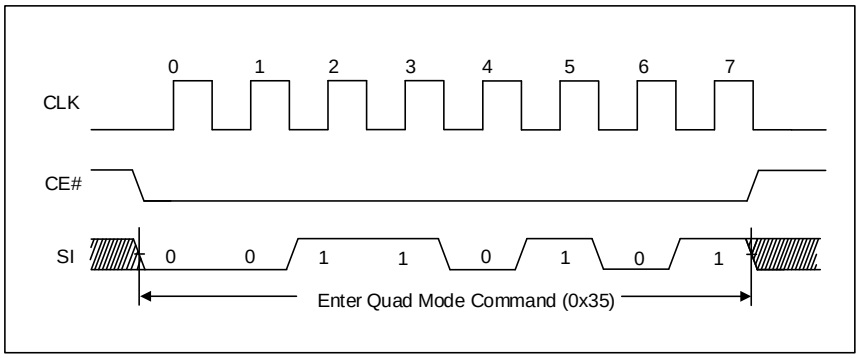



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## 5.3 QPI MODE

35h command switches the device into QPI mode.

**Figure 5.6 QPI Mode Enable, 0x35**





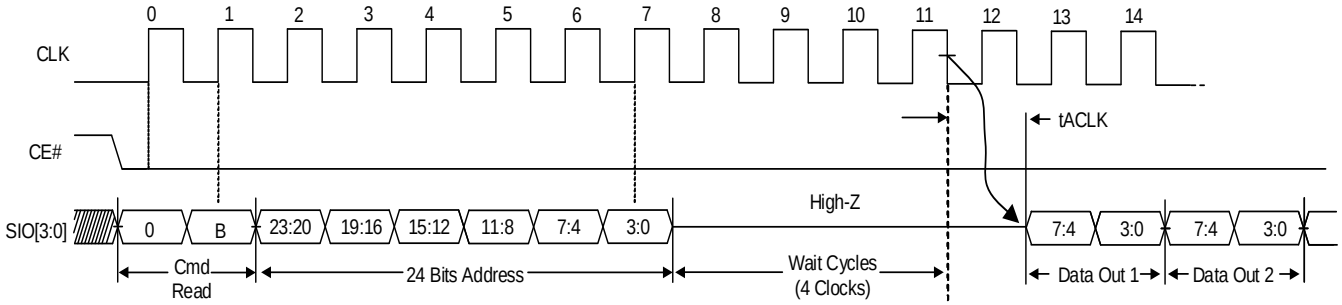
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### 5.4 QPI FAST READ OPERATION

For all reads in QPI mode, data will be available for tACLK after the falling edge of clock. QPI reads can be done in two ways:

03h: Quad CMD, Quad IO, fast frequency (up to 84MHz, 4 Wait Cycles)
0Bh: Quad CMD, Quad IO, fast frequency (up to 84MHz, 4 Wait Cycles)
EBh: Quad CMD, Quad IO, fast frequency (up to 104MHz, 6-Wait Cycles)

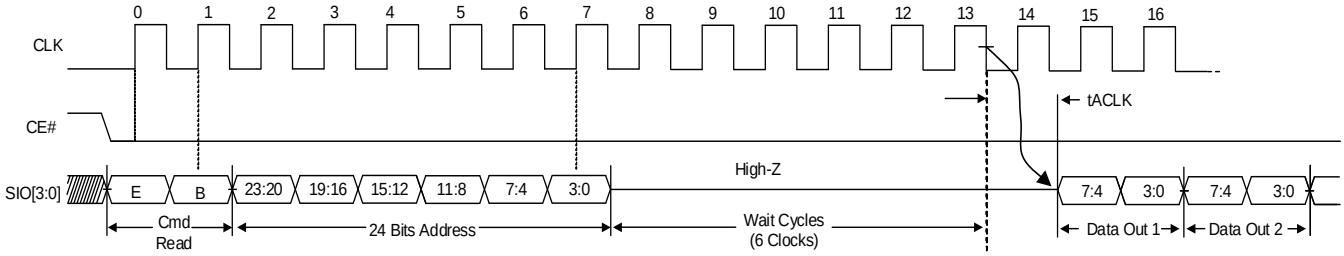
**Figure 5.7 QPI Fast Read, 03h/0Bh (Max Frequency: 84MHz)**




**Note:**

**1. Data out goes to High-Z after CE# transitions to HIGH (tHZ).**

**Figure 5.8 QPI Fast Read, EBh (Max Frequency: 104MHz)**




**Note:**

**1. Data out goes to High-Z after CE# transitions to HIGH (tHZ).**

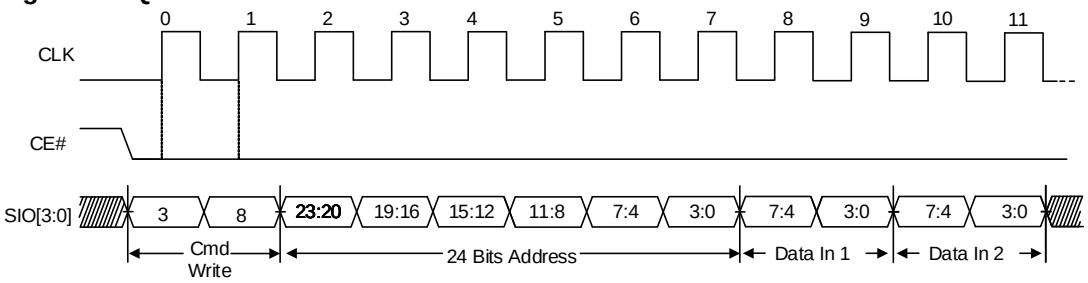


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## 5.5 QPI WRITE OPERATION

In QPI mode, either 02h or 38h command can be used for QPI write operation. It has nothing to do with maximum frequency.

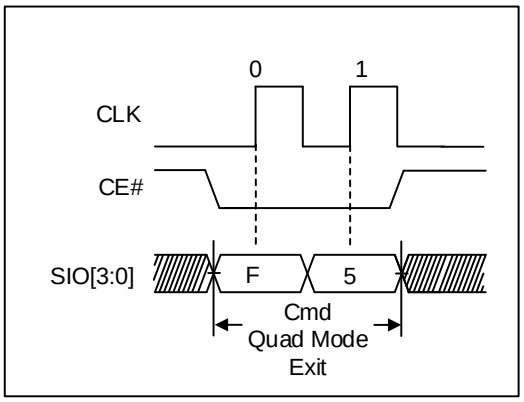
**Figure 5.9 QPI Write 02h or 38h**




## 5.6 QPI EXIT OPERATION

This command will switch the device back into SPI mode.

**Figure 5.10 QPI Mode Exit, F5h (Only available in QPI mode)**





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## 5.7 READ ID OPERATION

In SPI mode, this command is similar to Fast Read. But 24-bit address cycles are “don’t care” and there are no wait cycles between address and data.

In QPI mode, there is no address cycles, but there are 6 wait cycles between command and data.

**The data is wrapped to bit 7 of MF ID data again after bit 0 of EID data until CE# goes to HIGH.**

**Figure 5.11 SPI Read ID, 9Fh**

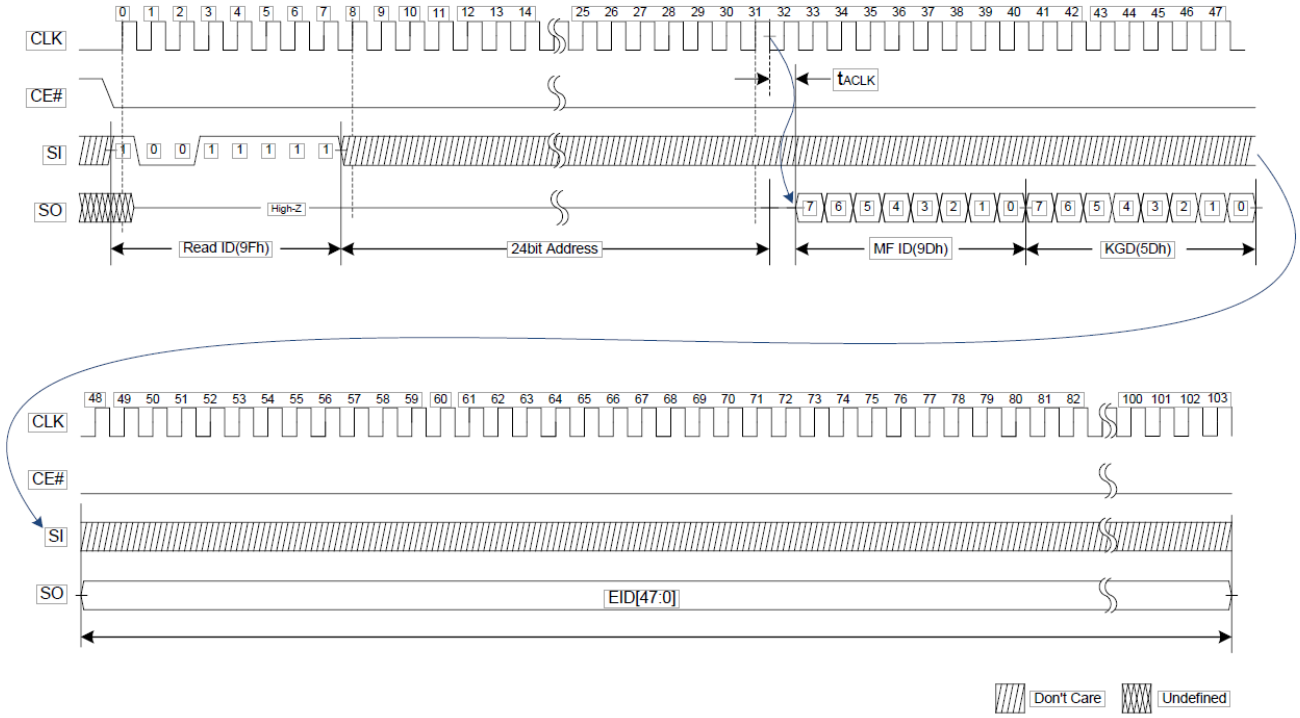
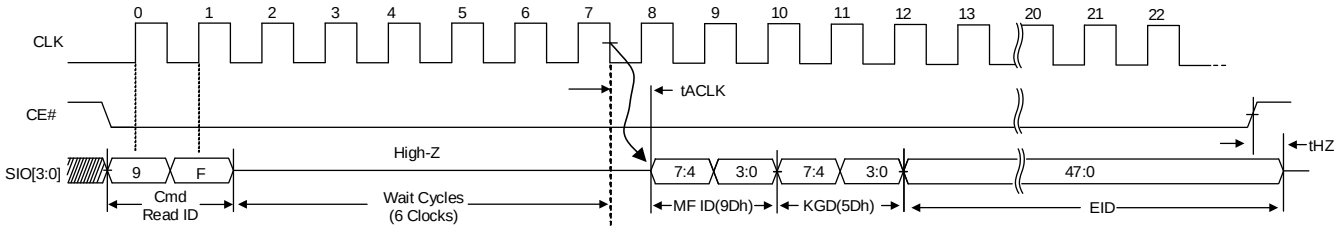



**Figure 5.12 QPI Read ID, 9Fh**




| KGD [7:0] | Known Good Die |
|---|---|
| ‘b0101_0101 | FAIL |
| ‘b0101_1101 | PASS |



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## 5.8 RESET OPERATION

### Software RESET

The software reset operation is used as a system reset that puts the device in SPI standby mode, which is also the default mode after power up. This operation consists of two commands: RESET Enable (0x66h) and RESET (RST, 0x99).

The reset operations requires the RESET ENABLE command to be followed by the RESET command. Any other command other than the RESET command after the RESET ENABLE command will disable the RESET ENABLE procedure.

**Figure 5.9 SPI RESET**

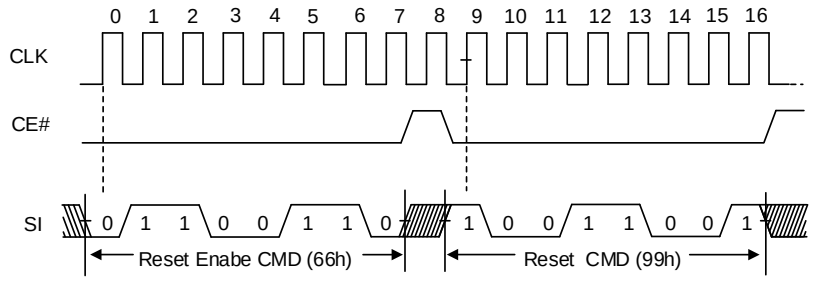
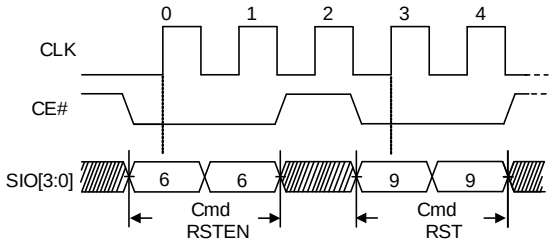



**Figure 5.10 QPI RESET**






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## 5.9 SET BURST LENGTH OPERATION

The Set Burst Operation toggles the device's burst length wrap between 1024 byte and 32 byte. Default burst length is 1024 byte.

**Figure 5.11 SPI Set Burst Length, C0h**

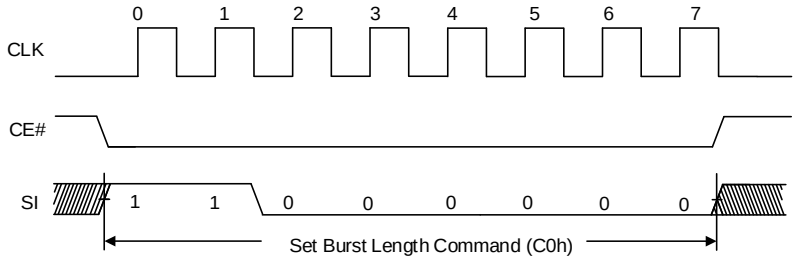
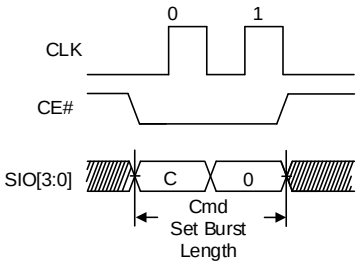



**Figure 5.11 QPI Set Burst Length C0h**





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### 5.10 IN-BAND RESET OPERATION

The device offers an additional feature of In-Band RESET function, which uses existing SPI signals to initiate a hardware reset, which is different from existing software reset/hardware reset (dedicated RESET# pin);

- Existing software reset commands often depend on the device being in a particular mode before they are effective. This makes software based reset sequences depend on slave device and mode.
- Dedicated RESET# pin requires additional pin over traditional 8-pins of SPI device. Also it requires 1 more signal for reset operation.

In Band-RESET operation requires 2-signal pins; CE# and SIO0.

- CE# is driven active low to select the SPI slave (note1)
- Clock (CLK) remains stable in either a high or low state ….(note 2)
- SIO0 is driven low by the bus master, simultaneously with CE# going active low……(note 3)
- CE# is driven inactive … (note 4)
- Repeat the above 4 steps, each time alternating the state of SIO0.
- After the fourth CE# pulse, the slave triggers its internal reset……..(note 5)

Note 1 This powers up the SPI slave
Note 2 This prevents any confusion with a command, as no command bits are transferred (clocked)
Note 3 No SPI bus slave drives SIO0 during CE# low before a transition of clock. Slave streaming output active is not allowed until after the first edge of clock.
Note 4 The slave captures the state of SIO0 on the rising edge of CE#
Note 5 SIO0 is low on the first CE#, high on the second, low on the third, high on the fourth … (This provides a 5th, unlike random noise)

**NOTE:**

This reset sequence is not intended to be used at normal power on, but to be used only when the device is not responding to the system. This reset sequence will be operational from any state that the device may be in. During the reset process, the device will ignore any chip select (command). In Band-Reset function is supported by optional device (option R) only.


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**Figure 5.12 Timing for In-Band RESET Operation**

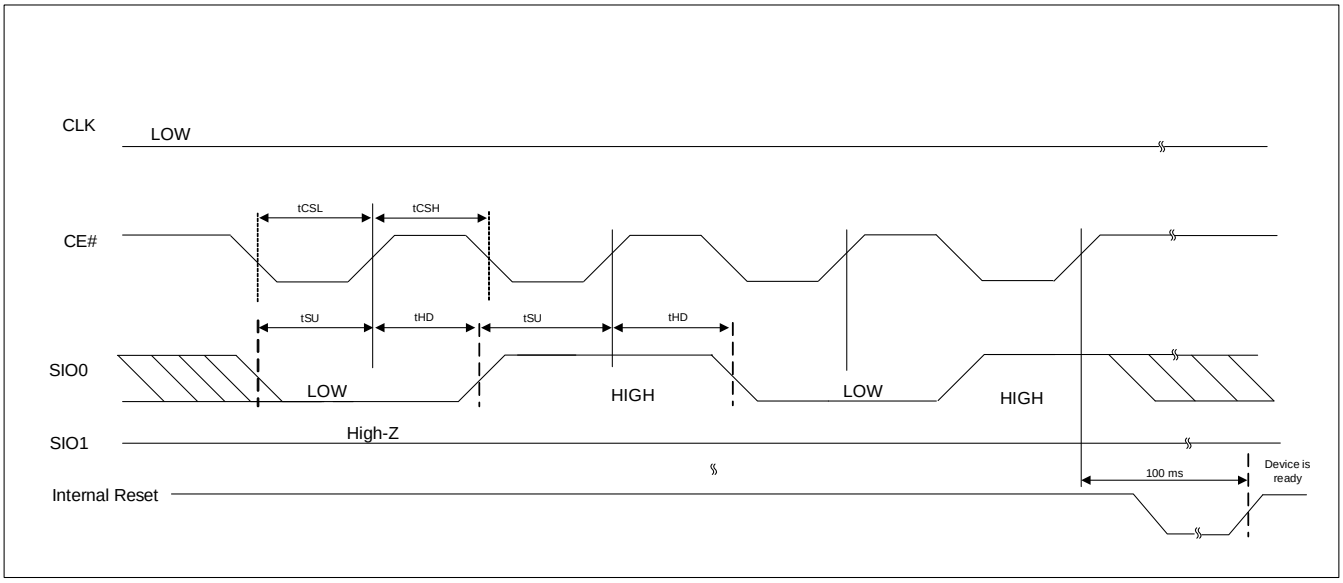



**Table 5.1 In-Band RESET Timing Parameters**

| Parameter | Symbol | Min | Max | Units |
|---|---|---|---|---|
| CE# Low Pulse | tCSL | 500 | -- | ns |
| CE# High Pulse | tCSH | 500 | -- | ns |
| Setup Time | tSU | 5 | -- | ns |
| Hold Time | tHD | 5 | -- | ns |


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## 5.11 DEEP POWER DOWN MODE

The Deep Power-down instruction (B9h) is for setting the device on the minimizing the power consumption (enter into Power-down mode). During this mode, standby current is reduced from $I_{sb1}$ to $I_{sb2}$ after tDPDIN.

**Figure 5.13 DEEP POWR DOWN ENTRY Timing (SPI MODE)**

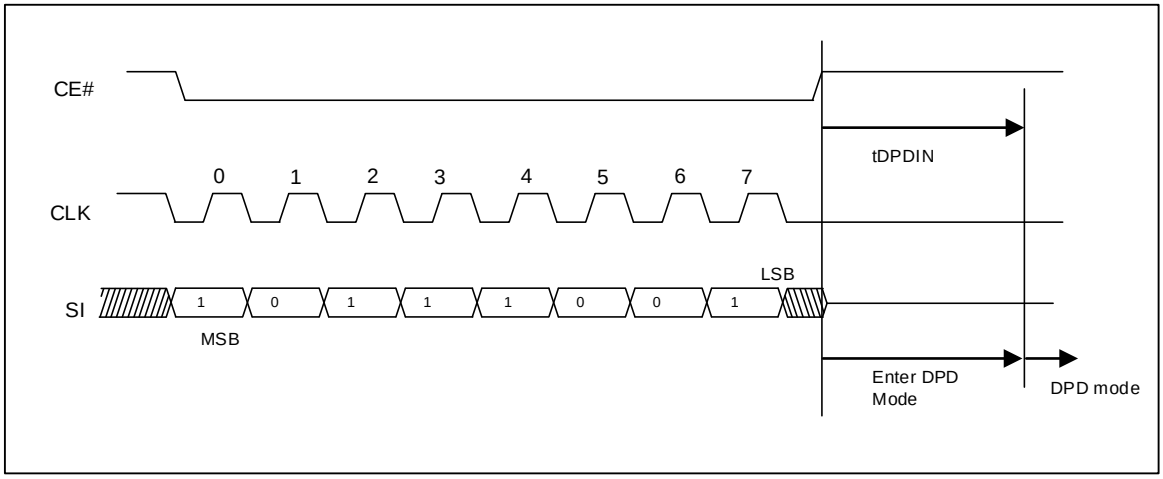
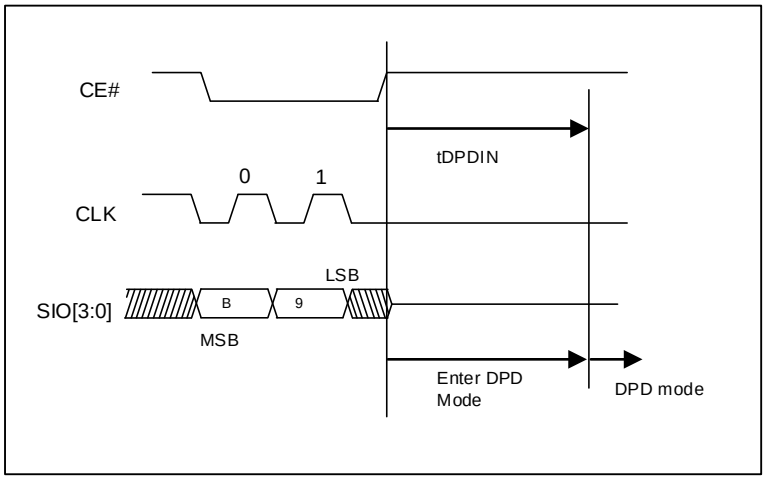



**Figure 5.14 DEEP POWR DOWN ENTRY Timing (QPI MODE)**





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**Figure 5.15 DEEP POWR DOWN EXIT Timing**

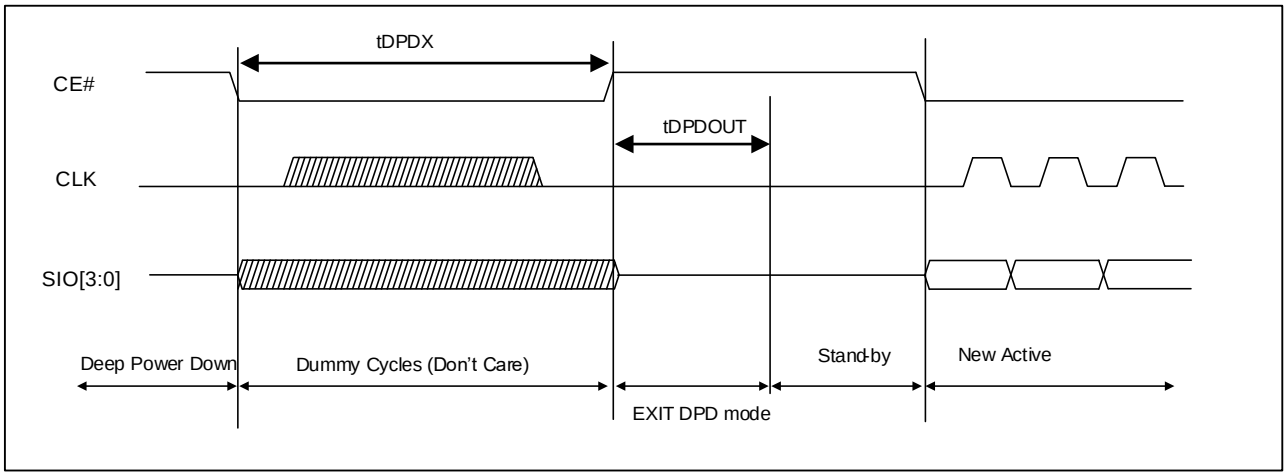



**Table 5.2 DEEP POWER DOWN Timing Parameters**

| Parameter | Description | Min | Max | Unit |
|---|---|---|---|---|
| tDPDIN | Deep Power Down Instruction (B9h) to DPD power level | 150 | - | us |
| tDPDX | CE# Low period to exit from Deep Power Down | 200 | - | ns |
| tDPDOUT | CE# Low then High to Standby wakeup time | - | 150 | us |


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# 6. REGISTER

The device has an 64 bit ID Register.

## 6.1 DEVICE IDENTIFICATION REGISTER

It is a read only, word register that provides device information. The device information fields can be identified as below.

a. Manufacturer
b. KGD Test
   i. Not Passed Yet (55h)
   ii. Passed (5Dh)
c. Density

**Table 6.2 ID Register**

| Bits | Function | Value |
|---|---|---|
| 63 - 56 | Manufacturer | 1001 1101 (9Dh) = ISSI |
| 55 - 48 | KGD Test | 0101 0101 (55h) = Not Passed Yet.<br>0101 1101 (5Dh) = PASS<br>Default value on this register is (0x55 = Not Passed Yet). After the all tests passed, then programmed as 0x5D (Pass) in manufacturing process. |
| 47 - 45 | Device Density | 000, 001= Reserved<br>010 = 32Mb<br>011 = 64Mb<br>100 = 128Mb<br>101~111 = Reserved. |
| 44 - 0 | Reserved | Reserved |


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# 7. ELECTRICAL CHARACTERISTICS

## 7.1 ABSOLUTE MAXIMUM RATINGS (1)

| | |
|---|---|
| Storage Temperature | -65°C to +150°C |
| Voltage with Respect to Ground on All Pins | -0.5V to $V_{CC}$ + 0.5V |
| Voltage on $V_{CC}$ supply relative to Ground | -0.5V to $V_{CC}$ + 0.5V |
| Electrostatic Discharge Voltage (Human Body Model)(2) | -2000V to +2000V |

**Notes:**
1. **Applied conditions greater than those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.**
2. **ANSI/ESDA/JEDEC JS-001**

## 7.2 OPERATING RANGE

| | | |
|---|---|---|
| Operating Temperature | Industrial Grade | -40°C to 85°C |
| | Automotive Grade A1 | -40°C to 85°C |
| | Automotive Grade A2 | -40°C to 105°C |
| $V_{CC}$ Power Supply | IS66/67WVS8M8F**ALL** | 1.65V (VMIN) –1.95V (VMAX); 1.8V (Typ) |
| | IS66/67WVS8M8F**BLL** | 2.7V (VMIN) –3.6V (VMAX); 3.0V (Typ) |


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## 7.3 DC CHARACTERISTICS

| Symbol | Parameter | | Min. | Typ. | Max. | Units | Test Conditions |
|---|---|---|---|---|---|---|---|
| Vcc | 3V | | 2.7 | 3.0 | 3.6 | V | |
| | 1.8V | | 1.65 | 1.8 | 1.95 | | |
| $I_{CC}$ | Average Operating Current | SPI@33MHz | - | - | 5 | mA | CE# ≤ Vcc - 0.2V, Others at 0.2V or Vcc - 0.2V, $I_{I/O}$ = 0mA, f=max |
| | | QPI@104MHz | - | - | 10 | | |
| $I_{SB1}$ | $V_{CC}$ Standby Current CMOS (85°C) | 3V | - | 150 | 200 | uA | CE# = $V_{CC}$, $V_{IN}$ = GND or $V_{CC}$ |
| | | 1.8V | | 120 | | | |
| | $V_{CC}$ Standby Current CMOS (105°C) | 3V | - | 150 | 250 | | |
| | | 1.8V | | 120 | | | |
| $I_{SB2}$ | Deep Power Down Current (85°C) | 3V | - | - | 30 | uA | CE#, VCC = 3.6V |
| | | 1.8V | - | - | 20 | | CE#, VCC = 1.95V |
| | Deep Power Down Current (105°C) | 3V | - | - | 35 | | CE#, VCC = 3.6V |
| | | 1.8V | - | - | 25 | | CE#, VCC = 1.95V |
| $V_{IL}$(2) | Input Low Voltage | 3V | -0.5 | - | $0.3V_{CC}$ | V | |
| | | 1.8V | -0.2 | - | 0.4 | | |
| $V_{IH}$(1) | Input High Voltage | 3V | $0.7V_{CC}$ | - | $V_{CC}$ + 0.3 | V | |
| | | 1.8V | VCC – 0.4 | - | VCC + 0.2 | | |
| $V_{OL}$ | Output Low Voltage | | - | - | 0.2VCC | V | $I_{OL}$ = 200 µA |
| $V_{OH}$ | Output High Voltage | | 0.8VCC | - | - | V | $I_{OH}$ = -200 µA |
| $I_{LI}$ | Input Leakage Current | | - | - | - | ±1 | $V_{IN}$ = 0V to $V_{CC}$ |
| $I_{LO}$ | Output Leakage Current | | - | - | - | ±1 | $V_{IN}$ = 0V to $V_{CC}$ |

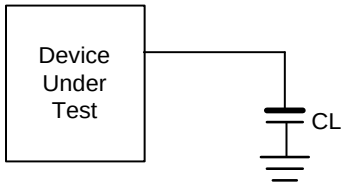
**Notes:**
1. **Input signals may overshoot $V_{CCQ}$ + 1.0V for periods less than 2ns during transitions.**
2. **Input signals may undershoot $V_{SSQ}$ - 1.0V for periods less than 2ns during transitions.**
3. **Typical values are included for reference only and are not guaranteed or tested. Typical values are measured at $V_{CC}$ = $V_{CC}$ (Typ).**


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## 7.4 AC MEASUREMENT CONDITIONS

| Parameter | Min | Max | Units |
|---|---|---|---|
| Output Load Capacitance, CL | | 30 | pF |
| Input Rise and Fall Slew rates (0.2*VCC to 0.8*VCC) | 1.5 | | V/ns |
| Input Pulse Voltage | 0.1*VCC to 0.9*VCC | | V |
| Input Timing Reference Voltages | VCC/2 | | V |
| Output Timing Reference Voltages | VCC/2 | | V |

**Figure 7.1 Test Setup**




## 7.5 PIN CAPACITANCE (TA = 25°C, VCC=1.8V/ 3V, 1MHZ)

| Symbol | Parameter | Test Condition | Min | Typ | Max | Units |
|---|---|---|---|---|---|---|
| $C_{IN}$ | Input Capacitance (CE#, CLK) | $V_{IN}$ = 0V | - | - | 6 | pF |
| $C_{IN/OUT}$ | Input/Output Capacitance (SIO0~SIO3) | $V_{IN/OUT}$ = 0V | - | - | 8 | pF |

**Note:**
**1. These parameters are characterized and not 100% tested.**


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### 7.6 AC CHARACTERISTICS

| Parameter | Symbol | Min. | Max. | Unit |
|---|---|---|---|---|
| Clock Cycle Time | tCLK@33MHz | 30 | - | ns |
| | tCLK@104MHz | 10 | - | ns |
| Clock Low width | tCH | 0.45 | 0.55 | tCLK |
| Clock High width | tCL | 0.45 | 0.55 | tCLK |
| Clock Rise/Fall Slew Rates (1) | tR/tF | 0.5 | - | V/ns |
| CE# Setup time to Active CLK edge | tCSP | 3 | - | ns |
| Input Setup time to Active CLK edge | tSP | 2.5 | - | ns |
| Input Hold time from\ Active CLK edge | tHD | 2 | - | ns |
| CLK falling to Output Valid | tACLK | | 7 | ns |
| Output Hold time from CLK falling | tOH | 1.5 | | ns |
| Chip Disable to DQ Output High-Z | tHZ | - | 7 | ns |
| CE# High between Subsequent operations | tCPH | 1 | | tCLK |
| Chip Select Maximum Low Time ( ~ 85°C ) | tCEM | - | 4 | us |
| Chip Select Maximum Low Time ( ~ 105°C ) | | - | 1 | us |

**Note:**

1. Value is guaranteed by design and/or characterization, not 100% tested in production.



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## 7.7 INPUT/OUTPUT TIMING

**Figure 7.2 Input Timing**

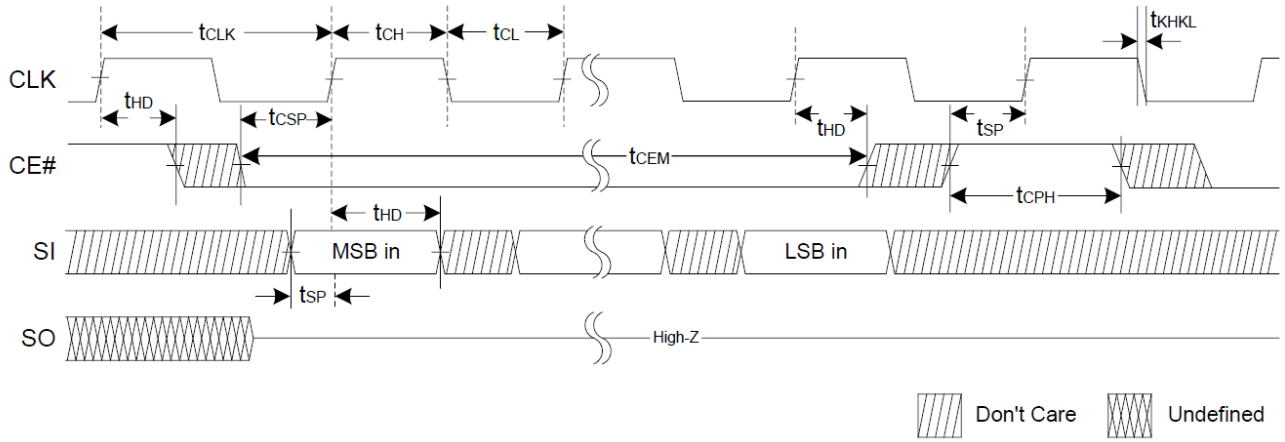
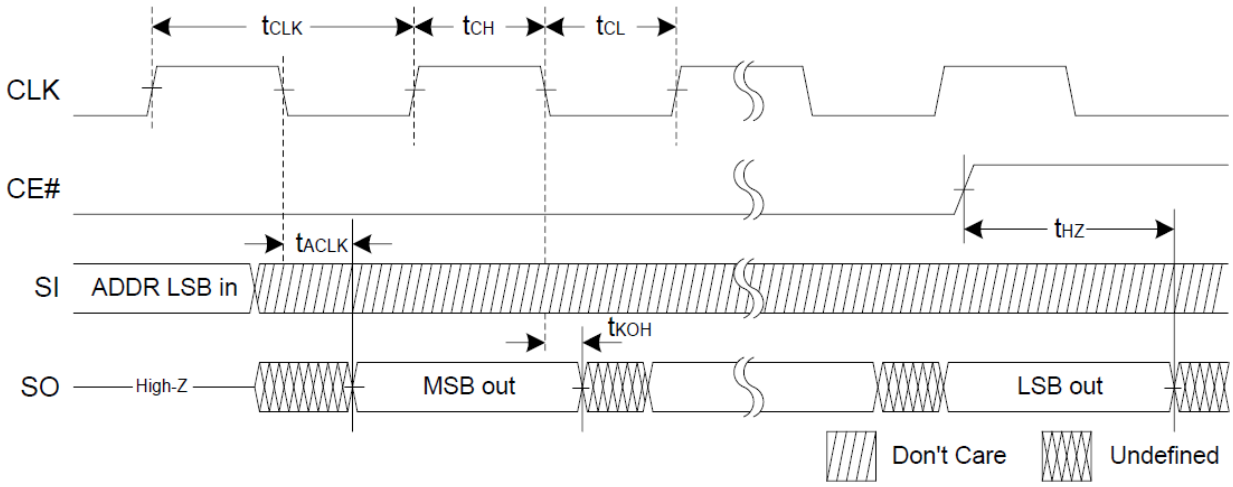



**Figure 7.3 Output Timing**

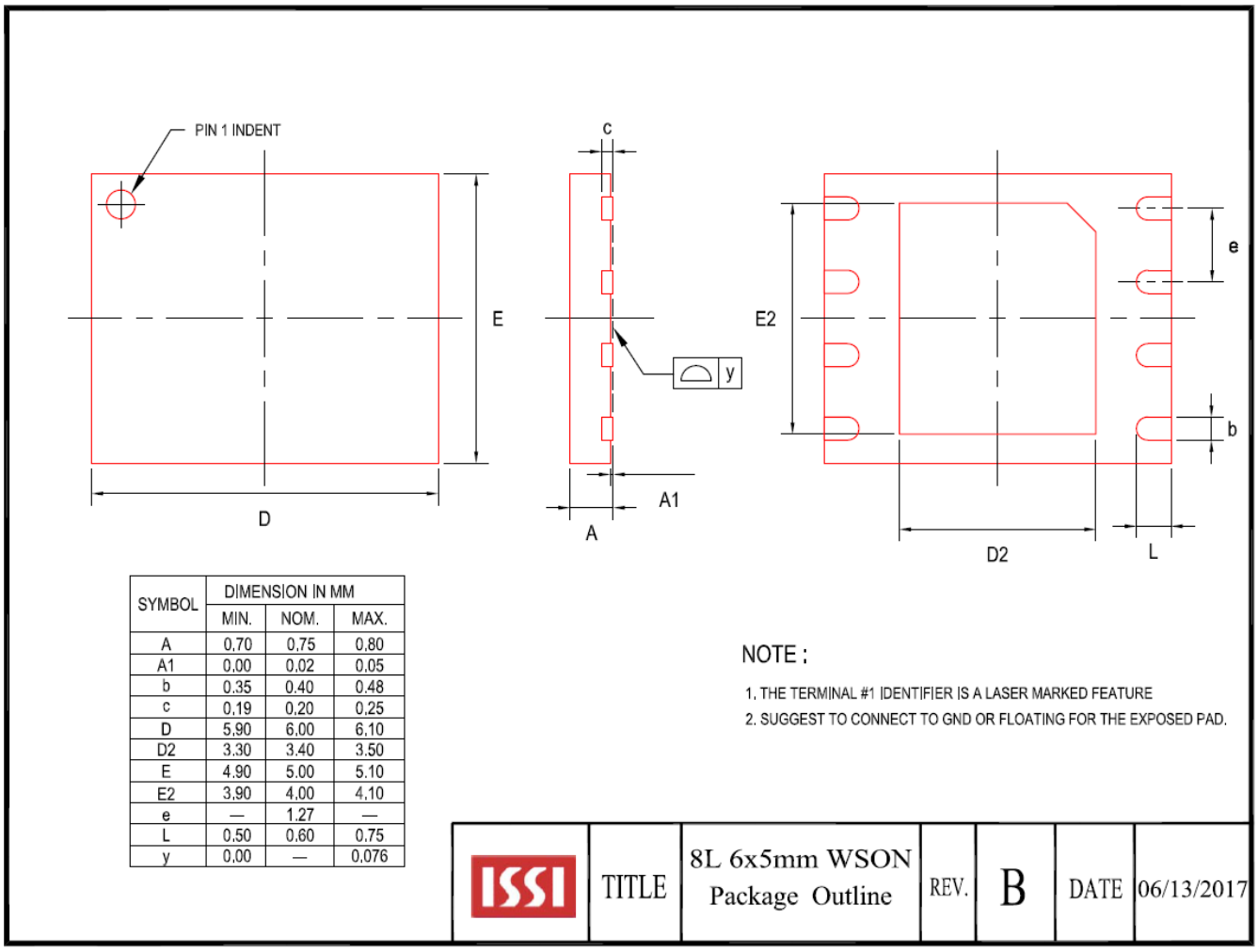





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# 8. PACKAGE TYPE INFORMATION

## 8.1 8- CONTACT ULTRA-THIN SMALL OUTLINE NO-LEAD (WSON) PACKAGE 6X5MM (K)




| SYMBOL | DIMENSION IN MM | | |
|---|---|---|---|
| | MIN. | NOM. | MAX. |
| A | 0.70 | 0.75 | 0.80 |
| A1 | 0.00 | 0.02 | 0.05 |
| b | 0.35 | 0.40 | 0.48 |
| c | 0.19 | 0.20 | 0.25 |
| D | 5.90 | 6.00 | 6.10 |
| D2 | 3.30 | 3.40 | 3.50 |
| E | 4.90 | 5.00 | 5.10 |
| E2 | 3.90 | 4.00 | 4.10 |
| e | — | 1.27 | — |
| L | 0.50 | 0.60 | 0.75 |
| y | 0.00 | — | 0.076 |

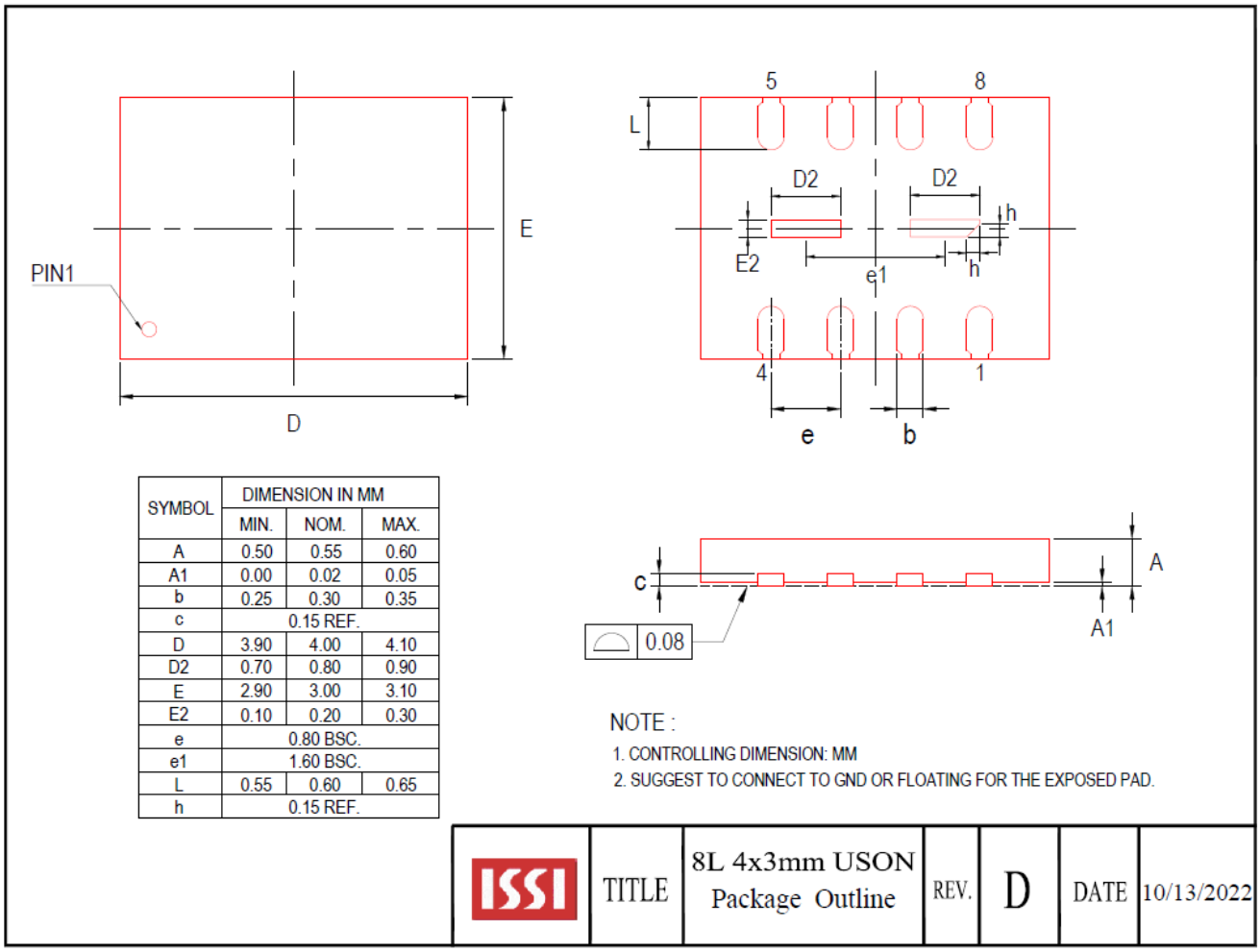
Note:

1. Please **click here** to refer to Application Note (AN25D011, Thin USON/WSON/XON package handling precautions) for assembly guidelines.



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## 8.2 8- CONTACT ULTRA-THIN SMALL OUTLINE NO-LEAD (USON) PACKAGE 4X3MM (T)




| SYMBOL | DIMENSION IN MM | | |
|---|---|---|---|
| | MIN. | NOM. | MAX. |
| A | 0.50 | 0.55 | 0.60 |
| A1 | 0.00 | 0.02 | 0.05 |
| b | 0.25 | 0.30 | 0.35 |
| c | | 0.15 REF. | |
| D | 3.90 | 4.00 | 4.10 |
| D2 | 0.70 | 0.80 | 0.90 |
| E | 2.90 | 3.00 | 3.10 |
| E2 | 0.10 | 0.20 | 0.30 |
| e | | 0.80 BSC. | |
| e1 | | 1.60 BSC. | |
| L | 0.55 | 0.60 | 0.65 |
| h | | 0.15 REF. | |

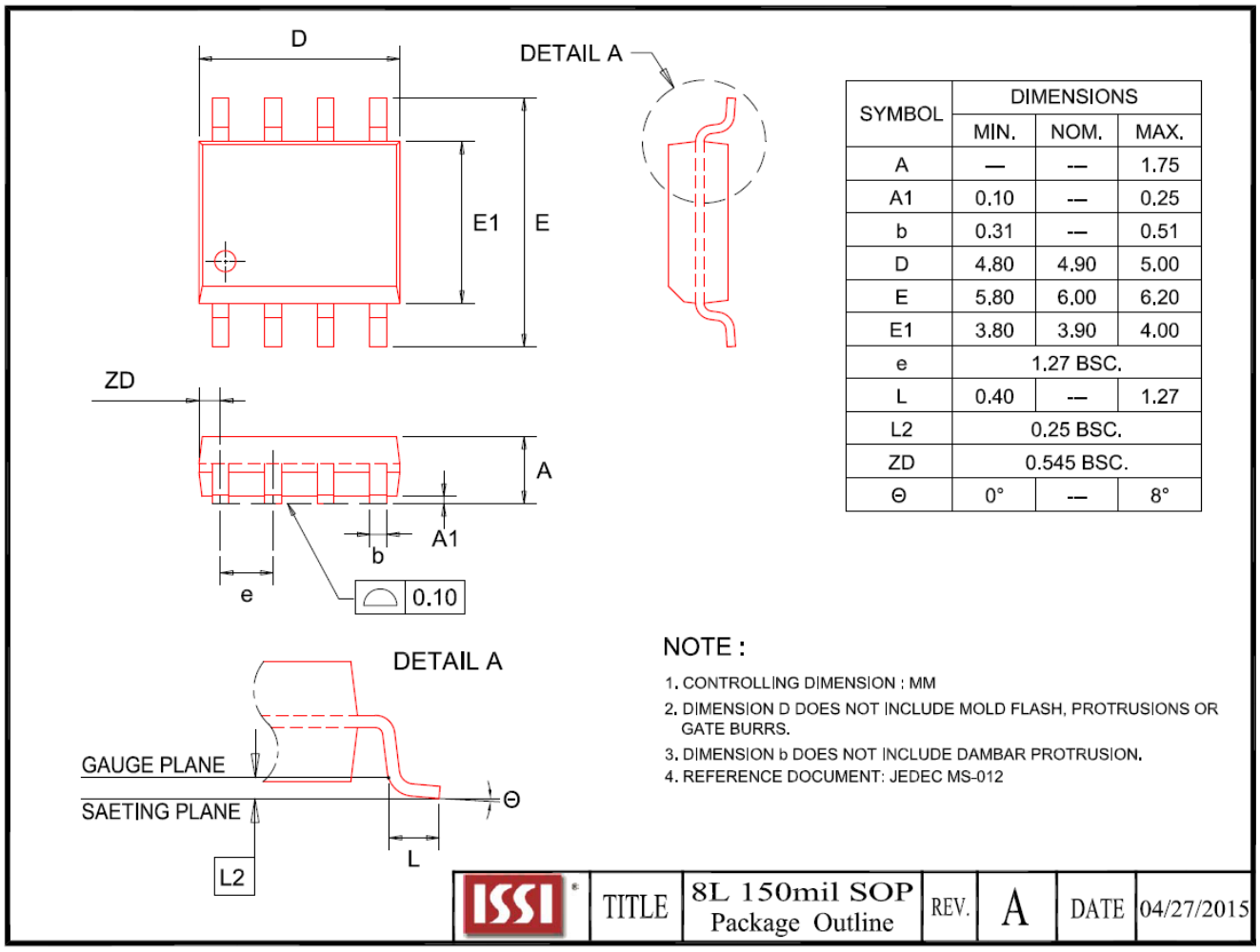
Note:

1. Please **click here** to refer to Application Note (AN25D011, Thin USON/WSON/XSON package handling precautions) for assembly guidelines.



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### 8.3 8-PIN JEDEC 150MIL BROAD SMALL OUTLINE INTEGRATED CIRCUIT (SOIC) PACKAGE (N)




| SYMBOL | DIMENSIONS | | |
|---|---|---|---|
| | MIN. | NOM. | MAX. |
| A | — | --- | 1.75 |
| A1 | 0.10 | --- | 0.25 |
| b | 0.31 | --- | 0.51 |
| D | 4.80 | 4.90 | 5.00 |
| E | 5.80 | 6.00 | 6.20 |
| E1 | 3.80 | 3.90 | 4.00 |
| e | 1.27 BSC. | | |
| L | 0.40 | --- | 1.27 |
| L2 | 0.25 BSC. | | |
| ZD | 0.545 BSC. | | |
| Θ | 0° | --- | 8° |

NOTE :

1. CONTROLLING DIMENSION : MM
2. DIMENSION D DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
3. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION.
4. REFERENCE DOCUMENT: JEDEC MS-012

| TITLE | 8L 150mil SOP Package Outline | REV. | A | DATE | 04/27/2015 |
|---|---|---|---|---|---|



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### 8.4 12-BALL WLCSP (Y)

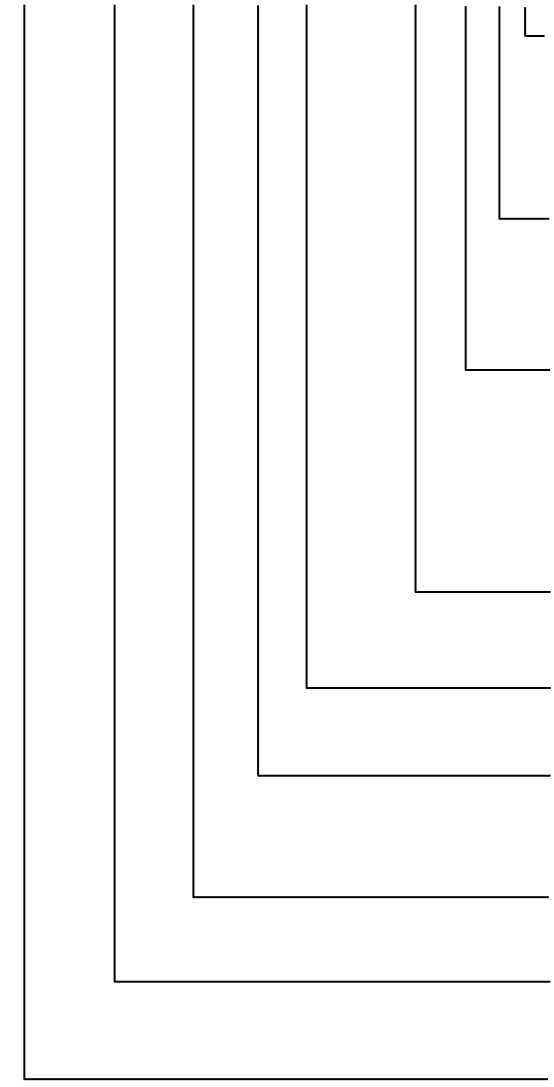
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## 9. ORDERING INFORMATION – Valid Part Numbers

**IS66 WVS 8M8 F ALL - 104 N L I**



**TEMPERATURE RANGE**
I = Industrial (-40°C to +85°C)
A1 = Automotive Grade (-40°C to +85°C)
A2 = Automotive Grade (-40°C to +105°C)

**PACKAGING CONTENT**
L = Green Package (RoHS Compliant, Halogen-free) and TSCA Compliant

**PACKAGE Type**
N = 8-pin SOIC 150mil
K = 8-contact WSON 6x5mm
T = 8-contact USON 4x3mm
Y = 12-ball WLCSP (Call Factory)
W = KGD (Call Factory)

**Frequency**
104 = 104MHz

**VDD**
ALL = 1.8V
BLL = 3.0V

**Die Revision**
F = die rev F

**Density/Org.**
8M8 = 8Mbx8=64Mb

**PSRAM Product Type.**
WVS = SerialRAM

**BASE PART NUMBER**
**IS = Integrated Silicon Solution Inc.**
66 = PSRAM
67 = PSRAM for Automotive


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Industrial Temperature Range (-40°C to +85°C)

| Config. | Voltage | Frequency (MHz) | Order Part Number | Package |
|---|---|---|---|---|
| 8Mbx8 | 1.8V | 104 | IS66WVS8M8FALL-104KLI | 8-contact WSON 6x5mm |
| | | | IS66WVS8M8FALL-104TLI | 8-contact USON 4x3mm |
| | | | IS66WVS8M8FALL-104NLI | 8-pin SOIC 150mil |
| | 3.0V | 104 | IS66WVS8M8FBLL-104KLI | 8-contact WSON 6x5mm |
| | | | IS66WVS8M8FBLL-104TLI | 8-contact USON 4x3mm |
| | | | IS66WVS8M8FBLL-104NLI | 8-pin SOIC 150mil |

Automotive A1 Temperature Range (-40°C to +85°C)

| Config. | Voltage | Frequency (MHz) | Order Part Number | Package |
|---|---|---|---|---|
| 8Mbx8 | 1.8V | 104 | IS67WVS8M8FALL-104KLA1 | 8-contact WSON 6x5mm |
| | | | IS67WVS8M8FALL-104TLA1 | 8-contact USON 4x3mm |
| | | | IS67WVS8M8FALL-104NLA1 | 8-pin SOIC 150mil |
| | 3.0V | 104 | IS67WVS8M8FBLL-104KLA1 | 8-contact WSON 6x5mm |
| | | | IS67WVS8M8FBLL-104TLA1 | 8-contact USON 4x3mm |
| | | | IS67WVS8M8FBLL-104NLA1 | 8-pin SOIC 150mil |

Automotive A2 Temperature Range (-40°C to +105°C)

| Config. | Voltage | Frequency (MHz) | Order Part Number | Package |
|---|---|---|---|---|
| 8Mbx8 | 1.8V | 104 | IS67WVS8M8FALL-104KLA2 | 8-contact WSON 6x5mm |
| | | | IS67WVS8M8FALL-104TLA2 | 8-contact USON 4x3mm |
| | | | IS67WVS8M8FALL-104NLA2 | 8-pin SOIC 150mil |
| | 3.0V | 104 | IS67WVS8M8FBLL-104KLA2 | 8-contact WSON 6x5mm |
| | | | IS67WVS8M8FBLL-104TLA2 | 8-contact USON 4x3mm |
| | | | IS67WVS8M8FBLL-104NLA2 | 8-pin SOIC 150mil |


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